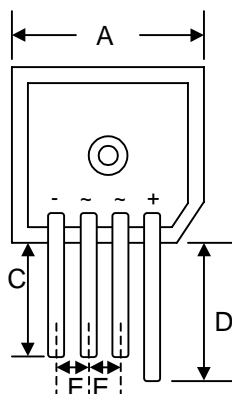


### Features

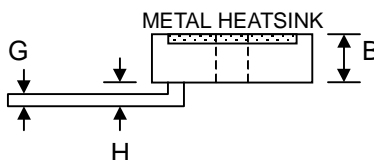
- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards
- Designed for Saving Mounting Space
- UL Recognized File # E157705

### Mechanical Data

- Case: Epoxy Case with Heat Sink Internally Mounted in the Bridge Encapsulation
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 30 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



KBPC-S		
Dim	Min	Max
A	28.40	28.70
B	10.97	11.23
C	13.90	—
D	19.10	—
E	5.10	—
G	1.20 Ø Typical	
H	3.05	3.60
All Dimensions in mm		



### Maximum Ratings and Electrical Characteristics @T<sub>A</sub>=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	KBPC 1000S	KBPC 1001S	KBPC 1002S	KBPC 1004S	KBPC 1006S	KBPC 1008S	KBPC 1010S	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @T <sub>A</sub> = 50°C	I <sub>O</sub>	10							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	200							A
Forward Voltage (per element) @I <sub>F</sub> = 5.0A	V <sub>FM</sub>	1.2							V
Peak Reverse Current @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 100°C	I <sub>R</sub>	10 1.0							µA mA
Rating for Fusing (t < 8.3ms) (Note 1)	I <sup>2</sup> <sub>t</sub>	374							A <sup>2</sup> s
Typical Thermal Resistance (Note 2)	R <sub>θJC</sub>	2.0							K/W
RMS Isolation Voltage from Case to Lead	V <sub>ISO</sub>	2500							V
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150							°C

Note: 1. Non-repetitive for t > 1ms and < 8.3ms.

2. Thermal resistance junction to case per element mounted on 8" x 8" x 25" thick AL plate.

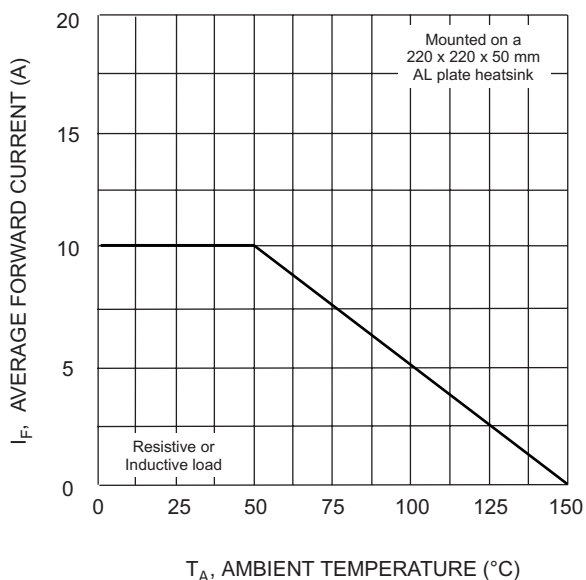


Fig. 1 Forward Current Derating Curve

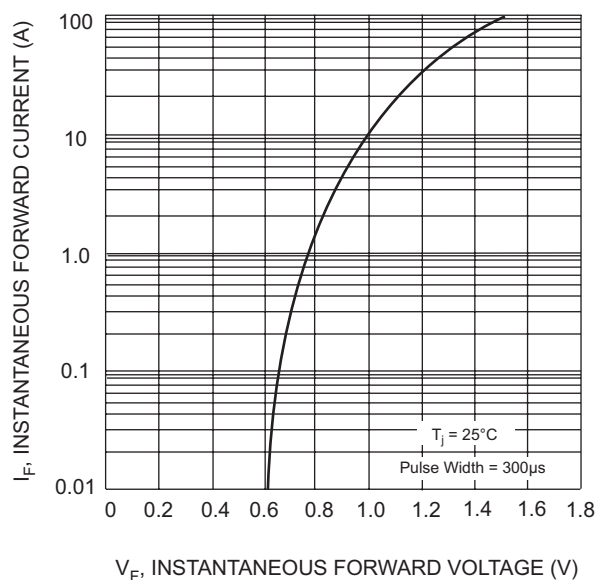


Fig. 2 Typical Forward Characteristics (per element)

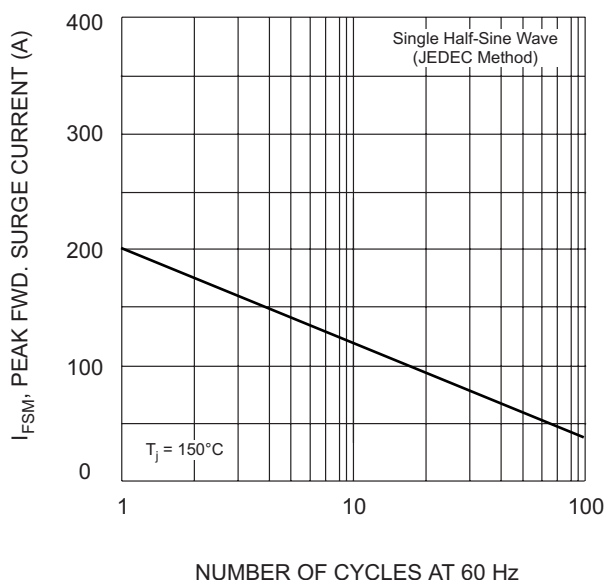


Fig. 3 Max Non-Repetitive Surge Current

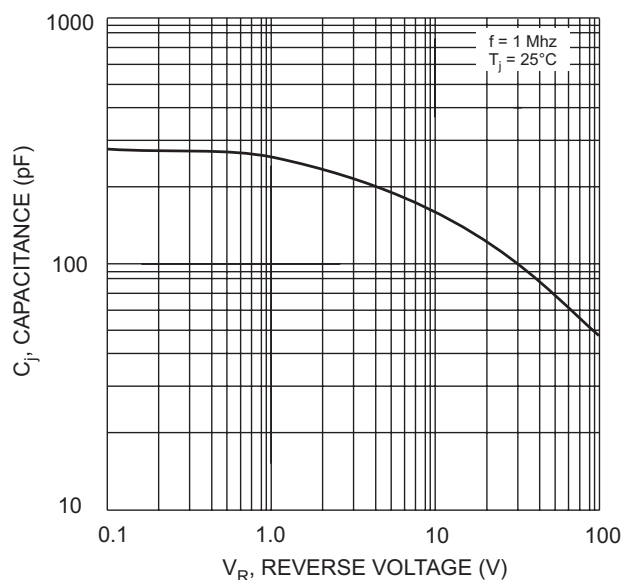


Fig. 4 Typical Junction Capacitance (per element)

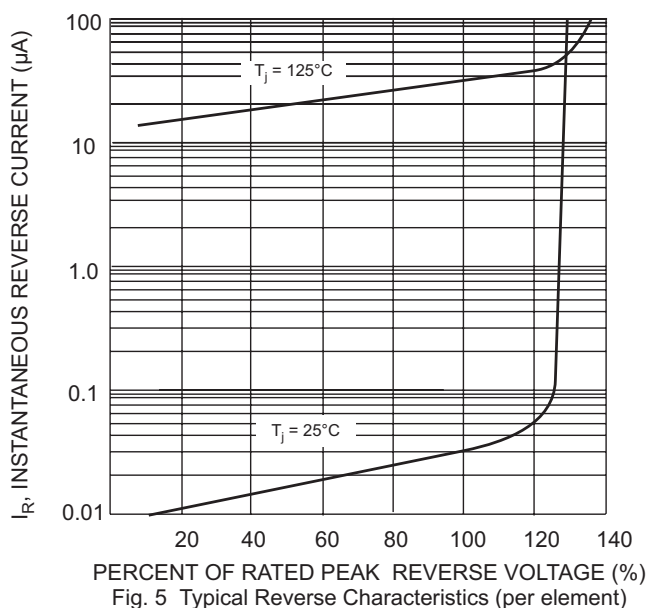


Fig. 5 Typical Reverse Characteristics (per element)

## ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
KBPC1000S	SIL Bridge	72 Units/Box
KBPC1001S	SIL Bridge	72 Units/Box
KBPC1002S	SIL Bridge	72 Units/Box
KBPC1004S	SIL Bridge	72 Units/Box
KBPC1006S	SIL Bridge	72 Units/Box
KBPC1008S	SIL Bridge	72 Units/Box
KBPC1010S	SIL Bridge	72 Units/Box

Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.

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